

Vishay Siliconix

# N-Channel 55 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a</sup>		
55	0.0200 at V <sub>GS</sub> = 10 V	35		
55	0.0260 at V <sub>GS</sub> = 4.5 V	30		

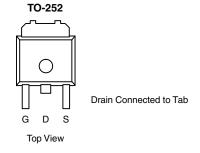
#### **FEATURES**

- TrenchFET® Power MOSFETS
- 175 °C Rated Maximum Junction Temperature

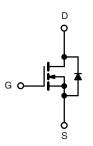
Low Input Capacitance

COMPLIANT

Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



**Ordering Information:** SUD35N05-26L-E3 (Lead (Pb)-free)



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)							
Parameter		Symbol	Limit	Unit			
Drain-Source Voltage		V <sub>DS</sub>	55	V			
Gate-Source Voltage	V <sub>GS</sub>	± 20	V				
Continuous Dunin Compant /T 175 96\h	T <sub>C</sub> = 25 °C		35				
Continuous Drain Current (T <sub>J</sub> = 175 °C) <sup>b</sup>	T <sub>C</sub> = 100 °C	I <sub>D</sub>	25	_			
Pulsed Drain Current		I <sub>DM</sub>	80	_ A			
Continuous Source Current (Diode Conduction) <sup>a</sup>	I <sub>S</sub>	35					
Manifesture Danier Dissipation	T <sub>C</sub> = 25 °C	В	50 <sup>c</sup>	14/			
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	7.5 <sup>b</sup>	- w			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Junction-to-Ambient <sup>b</sup>	t ≤ 10 s	- R <sub>thJA</sub>	17	20	0000		
Junction-to-Ambient	Steady State		50	60			
Junction-to-Case	R <sub>thJC</sub>	2.5	3	°C/W			
Junction-to-Lead	R <sub>thJL</sub>	5	6				

- a. Package limited.
- b. Surface mounted on 1" x1" FR4 board,  $t \le 10$  s.
- c. See SOA curve for voltage derating.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply.

# SUD35N05-26L

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<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Typ <sup>a</sup>	Max.	Unit	
Static				•			
Drain-Source Breakdown Voltage	$V_{BR}$ $V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$ 55		55			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Cuvvant		V <sub>DS</sub> = 44 V, V <sub>GS</sub> = 0 V			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 44 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50	μΑ	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 5 V	35			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0165	0.0200	Ω	
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A, T <sub>J</sub> = 125 °C			0.0350		
		$V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$		0.0215	0.0260	1	
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A		25		S	
Dynamic <sup>a</sup>				•			
Input Capacitance	C <sub>iss</sub>			885		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		185			
Reverse Transfer Capacitance	C <sub>rss</sub>			80			
Total Gate Charge <sup>c</sup>	$Q_g$			10.5	13		
Gate-Source Charge <sup>c</sup>	$Q_{gs}$	$V_{DS} = 25 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 35 \text{ A}$		4		nC	
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			4.8		1	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			5	8		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 25 \text{ V}, R_{L} = 0.3 \Omega$		18	30		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 35 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		20	30	ns	
Fall Time <sup>c</sup>	t <sub>f</sub>			100	150		
Source-Drain Diode Ratings and Cha	racteristic (T	<sub>C</sub> = 25 °C)					
Continuous Current	I <sub>S</sub>	l <sub>S</sub>			35	Α	
Pulsed Current	I <sub>SM</sub>				80		
Diode Forward Voltage <sup>b</sup>	$V_{SD}$	$I_F = 80 \text{ A}, V_{GS} = 0 \text{ V}$			1.5	V	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 35 A, di/dt = 100 A/μs		25	40	ns	

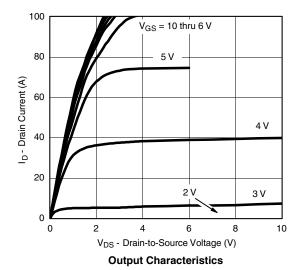
#### Notes:

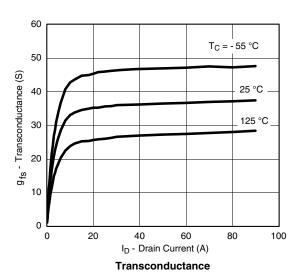
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- c. Independent of operating temperature.

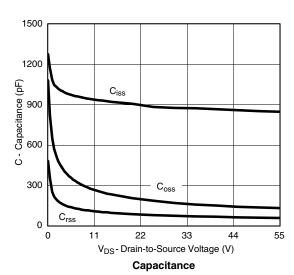
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

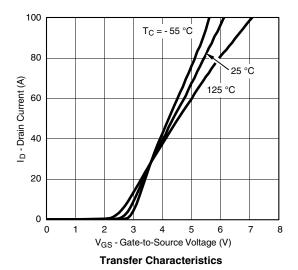


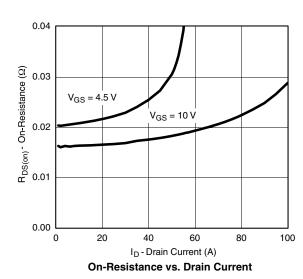
### TYPICAL CHARACTERISTICS (25 °C unless noted)

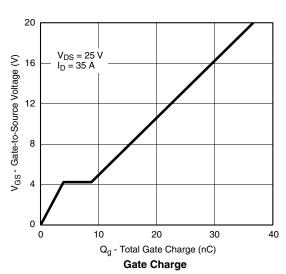






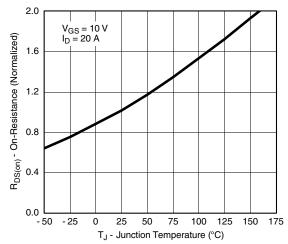






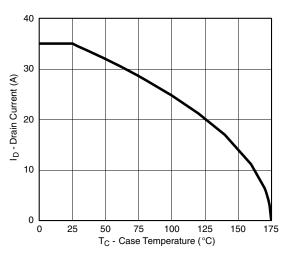
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#### TYPICAL CHARACTERISTICS (25 °C unless noted)

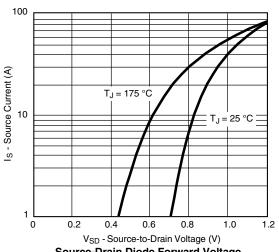


On-Resistance vs. Junction Temperature

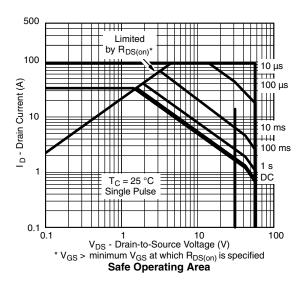
#### THERMAL RATINGS



Max. Avalanche and Drain Current vs. Case Temperature



Source-Drain Diode Forward Voltage



2 Duty Cycle = 0.5 Normalized Effective Transient Thermal Impedance 0.2 0.1 ngle Pulse 0.01 10<sup>-3</sup> . 10<sup>-4</sup> 10-2 10<sup>-1</sup> 10 30 Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Case

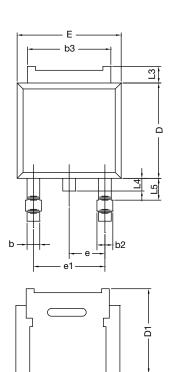
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?71443">www.vishay.com/ppg?71443</a>.

Document Number: 71443 S12-1360-Rev. C, 11-Jun-12 For more information please contact: pmostechsupport@vishay.com

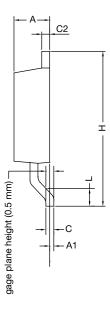




# **TO-252AA CASE OUTLINE**



E1



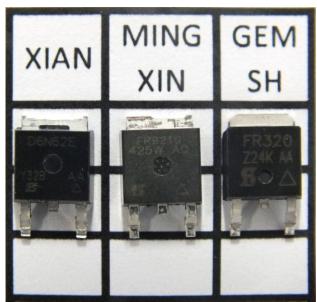
	MILLIMETERS		INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	2.18	2.38	0.086	0.094		
A1	-	0.127	-	0.005		
b	0.64	0.88	0.025	0.035		
b2	0.76	1.14	0.030	0.045		
b3	4.95	5.46	0.195	0.215		
С	0.46	0.61	0.018	0.024		
C2	0.46	0.89	0.018	0.035		
D	5.97	6.22	0.235	0.245		
D1	5.21	-	0.205	-		
Е	6.35	6.73	0.250	0.265		
E1	4.32	-	0.170	-		
Н	9.40	10.41	0.370	0.410		
е	2.28	BSC	0.090 BSC			
e1	4.56 BSC		0.180	BSC		
L	1.40	1.78	0.055	0.070		
L3	0.89	1.27	0.035	0.050		
L4	-	1.02	-	0.040		
L5	1.14	1.52	0.045	0.060		
FCN: X13-0073 Rev. N. 22-Apr-13						

ECN: X13-0073 Rev. N, 22-Apr-13

DWG: 5347

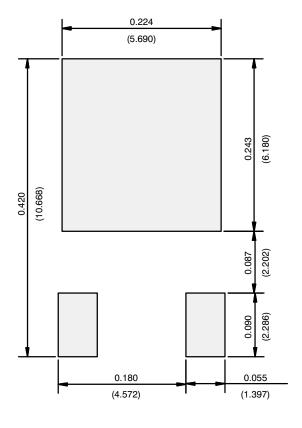
#### Notes

- Dimension L3 is for reference only.
- Xi'an, Mingxin, and GEM SH actual photo.





### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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